## SWITCHING <br> N-CHANNEL POWER MOS FET INDUSTRIAL USE

## DESCRIPTION

The 2SK2275 is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

## FEATURES

- Low On-state Resistance

Ros(on) $=2.8 \Omega \mathrm{MAX} .(\mathrm{VGS}=10 \mathrm{~V}, \mathrm{Id}=2.0 \mathrm{~A})$

- Low Ciss Ciss $=1000 \mathrm{pF}$ TYP.
- High Avalanche Capability Ratings

| ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ) |  |  |  |
| :---: | :---: | :---: | :---: |
| Drain to Source Voltage | Vdss | 900 | V |
| Gate to Source Voltage | Vgss | $\pm 30$ | V |
| Drain Current (DC) | ID (DC) | $\pm 3.5$ | A |
| Drain Current (pulse) | ld (pulse)* | * $\pm 14$ | A |
| Total Power Dissipation ( $\mathrm{Tc}=25^{\circ} \mathrm{C}$ ) | PT1 | 35 | W |
| Total Power Dissipation ( $\mathrm{Ta}_{\text {a }}=2{ }^{\circ} \mathrm{C}$ ) | Pt2 | 2.0 | W |
| Storage Temperature | $\mathrm{T}_{\text {stg }} \quad-5$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Channel Temperature | Tch | 150 | ${ }^{\circ} \mathrm{C}$ |
| Single Avalanche Current | IAs** | 3.5 | A |
| Single Avalanche Energy | EAS** | 22 | mJ |

*PW $\leq 10 \mu \mathrm{~s}$, Duty Cycle $\leq 1 \%$
**Starting Tch $=25^{\circ} \mathrm{C}, \mathrm{Rg}_{\mathrm{c}}=25 \Omega, \mathrm{~V}$ gs $=20 \mathrm{~V} \rightarrow 0$

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.


## ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| CHARACTERISTIC | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain to Source On-state Resistance | RDS(on) |  | 2.2 | 2.8 | $\Omega$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ld}=2 \mathrm{~A}$ |
| Gate to Source Cutoff Voltage | VGS(off) | 2.5 |  | 3.5 | V | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{ld}=1 \mathrm{~mA}$ |
| Forward Transfer Admittance | $\left\|y_{\text {fs }}\right\|$ | 1.0 |  |  | S | $V_{D S}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2 \mathrm{~A}$ |
| Drain Leakage Current | Idss |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=900 \mathrm{~V}, \mathrm{~V}_{\mathrm{Gs}}=0$ |
| Gate to Source Leakage Current | Igss |  |  | $\pm 10$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{Gs}}= \pm 30 \mathrm{~V}, \mathrm{~V}$ ds $=0$ |
| Input Capacitance | Ciss |  | 1000 |  | pF | $\mathrm{V} \mathrm{Ds}=10 \mathrm{~V}$ |
| Output Capacitance | Coss |  | 170 |  | pF | $V_{G S}=0$ |
| Reverse Transfer Capacitance | Crss |  | 60 |  | pF | $\mathrm{f}=1 \mathrm{MHz}$ |
| Turn-On Delay Time | tdon) |  | 20 |  | ns | $\mathrm{V}_{\mathrm{Gs}}=10 \mathrm{~V}$ |
| Rise Time | tr |  | 20 |  | ns | $V_{D D}=150 \mathrm{~V}$ |
| Turn-Off Delay Time | td(off) |  | 90 |  | ns | $\mathrm{ID}=2 \mathrm{~A}, \mathrm{R}_{\mathrm{g}}=10 \Omega$ |
| Fall Time | tf |  | 20 |  | ns | $\mathrm{RL}=75 \Omega$ |
| Total Gate Charge | Qg |  | 42 |  | nC | V Gs $=10 \mathrm{~V}$ |
| Gate to Source Charge | Qgs |  | 6.0 |  | nC | $\mathrm{ID}=3.5 \mathrm{~A}$ |
| Gate to Drain Charge | Qgd |  | 20 |  | nC | $V_{D D}=450 \mathrm{~V}$ |
| Diode Forward Voltage | $V_{\text {FIS-D) }}$ |  | 0.9 |  | V | $\mathrm{I}_{\mathrm{F}}=3.5 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0$ |
| Reverse Recovery Time | trr |  | 480 |  | ns | $1_{\text {F }}=3.5 \mathrm{~A}$ |
| Reverse Recovery Charge | Qrr |  | 2.5 |  | $\mu \mathrm{C}$ | $\mathrm{di} / \mathrm{dt}=50 \mathrm{~A} / \mu \mathrm{s}$ |

## Test Circuit 1: Avalanche Capability

Test Circuit 2: Switching Time


## Test Circuit 3: Gate Charge



The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

